



# 74VCX162245

## LOW VOLTAGE CMOS 16-BIT BUS TRANSCEIVER (3-STATE) WITH 3.6V TOLERANT INPUTS AND OUTPUTS

- 3.6V TOLERANT INPUTS AND OUTPUTS
- HIGH SPEED A OUTPUTS:  
 $t_{PD} = 3.4 \text{ ns (MAX.)}$  at  $V_{CC} = 3.0$  to  $3.6\text{V}$   
 $t_{PD} = 4.3 \text{ ns (MAX.)}$  at  $V_{CC} = 2.3$  to  $2.7\text{V}$   
 $t_{PD} = 5.7 \text{ ns (MAX.)}$  at  $V_{CC} = 1.8\text{V}$
- SYMMETRICAL IMPEDANCE A OUTPUTS:  
 $|I_{OH}| = I_{OL} = 12 \text{ mA (MIN)}$  at  $V_{CC} = 3.0\text{V}$   
 $|I_{OH}| = I_{OL} = 8 \text{ mA (MIN)}$  at  $V_{CC} = 2.3\text{V}$   
 $|I_{OH}| = I_{OL} = 4 \text{ mA (MIN)}$  at  $V_{CC} = 1.8\text{V}$
- HIGH SPEED B OUTPUTS:  
 $t_{PD} = 2.5 \text{ ns (MAX.)}$  at  $V_{CC} = 3.0$  to  $3.6\text{V}$   
 $t_{PD} = 3.0 \text{ ns (MAX.)}$  at  $V_{CC} = 2.3$  to  $2.7\text{V}$   
 $t_{PD} = 5.0 \text{ ns (MAX.)}$  at  $V_{CC} = 1.8\text{V}$
- SYMMETRICAL IMPEDANCE B OUTPUTS:  
 $|I_{OH}| = I_{OL} = 24 \text{ mA (MIN)}$  at  $V_{CC} = 3.0\text{V}$   
 $|I_{OH}| = I_{OL} = 18 \text{ mA (MIN)}$  at  $V_{CC} = 2.3\text{V}$   
 $|I_{OH}| = I_{OL} = 6 \text{ mA (MIN)}$  at  $V_{CC} = 1.8\text{V}$
- POWER-DOWN PROTECTION ON INPUTS AND OUTPUTS
- $26\Omega$  SERIE RESITORS IN A PORT OUTPUT
- OPERATING VOLTAGE RANGE:  
 $V_{CC} \text{ (OPR)} = 1.8\text{V to } 3.6\text{V}$
- PIN AND FUNCTION COMPATIBLE WITH 74 SERIES 16245
- LATCH-UP PERFORMANCE EXCEEDS 300mA
- ESD PERFORMANCE:  
 $\text{HBM} > 2000\text{V}; \text{MM} > 200\text{V}$

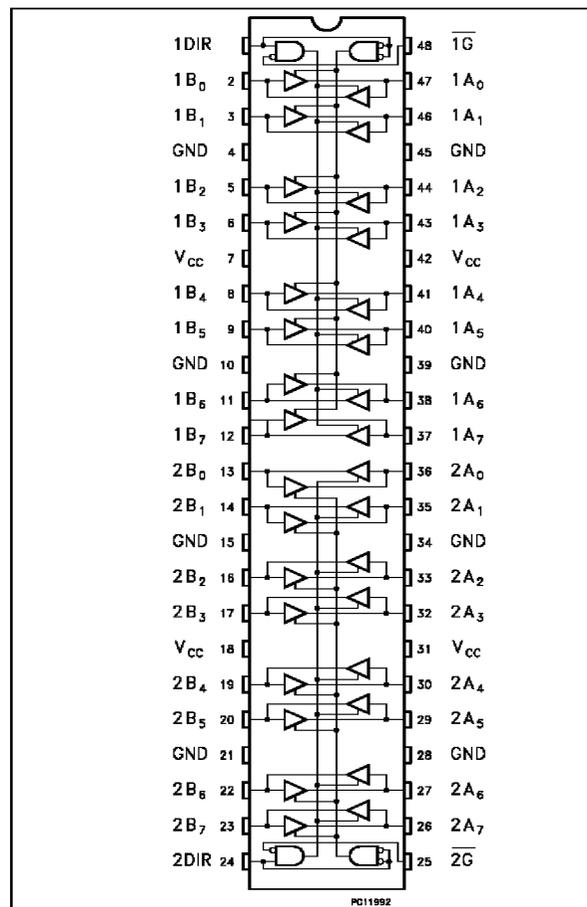
### DESCRIPTION

The VCX162245 is a low voltage CMOS 16-BIT BUS TRANSCEIVER (3-STATE) fabricated with sub-micron silicon gate and five layer metal wiring C<sup>2</sup>MOS technology. It is ideal for low power and very high speed 1.8 to 3.6V applications; it can be interfaced to 3.6V signal enviroment for both inputs and outputs.

This IC is intended for two-way asynchronous communication beetwen data buses; the direction of data trasmission is determined by DIR input. The two enable inputs  $\overline{nG}$  can be used to disable the device so that the buses are effectively isolated. The device circuits is including  $26\Omega$  series resistance in the A port outputs. These resistors permit to reduce line noise in high speed applications. All inputs and outputs are equipped



### PIN CONNECTION



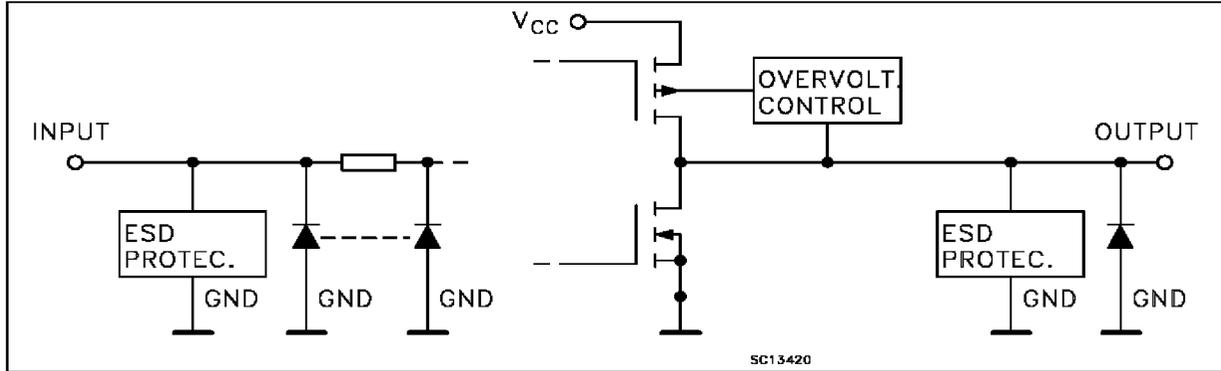
# 74VCX162245

with protection circuits against static discharge, giving them 2KV ESD immunity and transient excess voltage.

NOTE: IT IS PROHIBITED TO APPLY A SIGNAL TO A TERMINAL WHEN IT IS IN OUTPUT

MODE AND WHEN A BUS THERMINAL IS FLOATING (HIGH IMPEDANCE STATE) IT IS REQUESTED TO FIX THE INPUT LEVEL BY MEANS OF EXTERNAL PULL DOWN OR PULL UP RESISTOR.

## INPUT AND OUTPUT EQUIVALENT CIRCUIT



## PIN DESCRIPTION

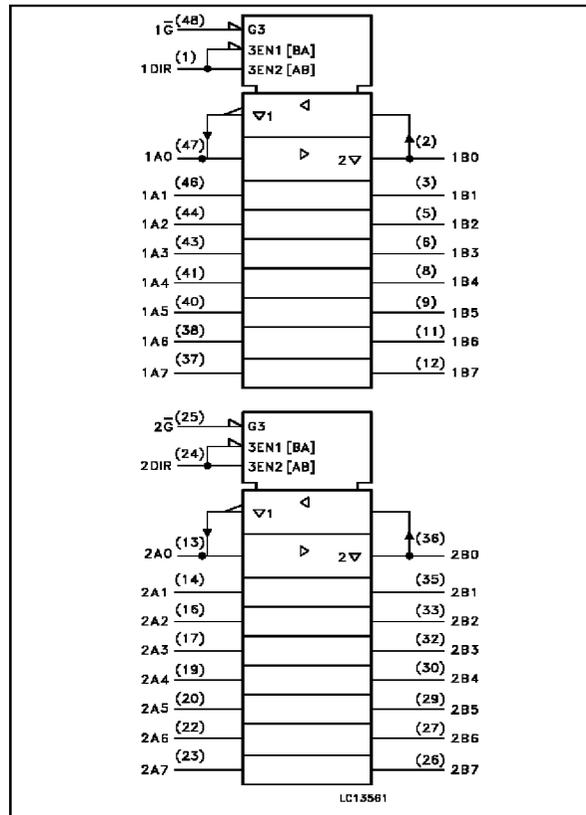
PIN No	SYMBOL	NAME AND FUNCTION
1	1DIR	Directional Control
2, 3, 5, 6, 8, 9, 11, 12	1B0 to 1B7	Data Inputs/Outputs
13, 14, 16, 17, 19, 20, 22, 23	2B0 to 2B7	Data Inputs/Outputs
24	2DIR	Directional Control
25	$\overline{2G}$	Output Enabel Input
36, 35, 33, 32, 30, 29, 27, 26	2A0 to 2A7	Data Inputs/Outputs
47, 46, 44, 43, 41, 40, 38, 37	1A0 to 1A7	Data Inputs/Outputs
48	$\overline{1G}$	Output Enabel Input
4, 10, 15, 21, 28, 34, 39, 45	GND	Ground (0V)
7, 18, 31, 42	V <sub>CC</sub>	Positive Supply Voltage

## TRUTH TABLE

INPUT		FUNCTION		OUTPUT
$\overline{G}$	DIR	A BUS	B BUS	
L	L	OUTPUT	INPUT	A = B
L	H	INPUT	OUTPUT	B = A
H	X	Z	Z	Z

X: "H" or "L"  
Z: High impedance

## IEC LOGIC SYMBOLS



**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage	-0.5 to + 4.6	V
V <sub>I</sub>	DC Input Voltage	-0.5 to + 4.6	V
V <sub>O</sub>	DC Output Voltage (OFF state)	-0.5 to + 4.6	V
V <sub>O</sub>	DC Output Voltage (High or Low State) (note1)	-0.5 to V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	DC Input Diode Current	- 50	mA
I <sub>OK</sub>	DC Output Diode Current (note2)	± 50	mA
I <sub>O</sub>	DC Output Source/Sink Current	± 50	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current Per Supply Pin	± 100	mA
P <sub>D</sub>	Power Dissipation	400	mW
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C
T <sub>L</sub>	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

1) I<sub>O</sub> absolute maximum rating must be observed

2) V<sub>O</sub> < GND, V<sub>O</sub> > V<sub>CC</sub>

**RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage	1.8 to 3.6	V
V <sub>I</sub>	Input Voltage	-0.3 to 3.6	V
V <sub>O</sub>	Output Voltage (OFF state)	0 to 3.6	V
V <sub>O</sub>	Output Voltage (High or Low State)	0 to V <sub>CC</sub>	V
I <sub>OH</sub> , I <sub>OL</sub>	High or Low Level Output Current - A side (V <sub>CC</sub> =3.0 to 3.6V)	± 12	mA
I <sub>OH</sub> , I <sub>OL</sub>	High or Low Level Output Current - A side (V <sub>CC</sub> =2.3 to 2.7V)	± 8	mA
I <sub>OH</sub> , I <sub>OL</sub>	High or Low Level Output Current - A side (V <sub>CC</sub> = 1.8V)	± 4	mA
I <sub>OH</sub> , I <sub>OL</sub>	High or Low Level Output Current - B side (V <sub>CC</sub> =3.0 to 3.6V)	± 24	mA
I <sub>OH</sub> , I <sub>OL</sub>	High or Low Level Output Current - B side (V <sub>CC</sub> =2.3 to 2.7V)	± 18	mA
I <sub>OH</sub> , I <sub>OL</sub>	High or Low Level Output Current - B side (V <sub>CC</sub> = 1.8V)	± 6	mA
T <sub>op</sub>	Operating Temperature:	-40 to +85	°C
dt/dv	Input Transition Rise or Fall Rate (V <sub>CC</sub> = 3.0V) (note 1)	0 to 10	ns/V

1) V<sub>IN</sub> from 0.8V to 2.0V, V<sub>CC</sub>=3.0V

DC SPECIFICATIONS (2.7V < V<sub>CC</sub> ≤ 3.6V unless otherwise specified)

Symbol	Parameter	Test Conditions		Value		Unit
		V <sub>CC</sub> (V)		-40 to 85 °C		
				Min.	Max.	
V <sub>IH</sub>	High Level Input Voltage	2.7 to 3.6		2.0		V
V <sub>IL</sub>	Low Level Input Voltage					0.8
V <sub>OH</sub>	High Level Output Voltage (A Outputs)	2.7 to 3.6	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = -100 μA	V <sub>CC</sub> - 0.2	V
		2.7		I <sub>O</sub> = 6 mA	2.2	
		3.0		I <sub>O</sub> = 8 mA	2.4	
		3.0		I <sub>O</sub> = 12 mA	2.2	
V <sub>OH</sub>	High Level Output Voltage (B Outputs)	2.7 to 3.6	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = -100 μA	V <sub>CC</sub> - 0.2	V
		2.7		I <sub>O</sub> = 12 mA	2.2	
		3.0		I <sub>O</sub> = 18 mA	2.4	
		3.0		I <sub>O</sub> = 24 mA	2.2	
V <sub>OL</sub>	Low Level Output Voltage (A Outputs)	2.7 to 3.6	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = 100 μA		V
		2.7		I <sub>O</sub> = 6 mA	0.4	
		3.0		I <sub>O</sub> = 8 mA	0.5	
		3.0		I <sub>O</sub> = 12 mA	0.8	
V <sub>OL</sub>	Low Level Output Voltage (B Outputs)	2.7 to 3.6	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = 100 μA		V
		2.7		I <sub>O</sub> = 12 mA	0.4	
		3.0		I <sub>O</sub> = 18 mA	0.4	
		3.0		I <sub>O</sub> = 24 mA	0.55	
I <sub>I</sub>	Input Leakage Current	2.7 to 3.6	V <sub>I</sub> = 0 to 3.6 V		±5	μA
I <sub>OZ</sub>	3 State Output Leakage Current	2.7 to 3.6	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>O</sub> = 0 to 3.6V		±10	μA
I <sub>off</sub>	Power Off Leakage Current	0	V <sub>I</sub> or V <sub>O</sub> = 0 to 3.6V		10	μA
I <sub>CC</sub>	Quiescent Supply Current	2.7 to 3.6	V <sub>I</sub> = V <sub>CC</sub> or GND		20	μA
			V <sub>I</sub> or V <sub>O</sub> = V <sub>CC</sub> to 3.6 V		±20	
ΔI <sub>CC</sub>	ICC incr. per input	2.7 to 3.6	V <sub>IH</sub> = V <sub>CC</sub> - 0.6V		750	μA

DC SPECIFICATIONS (2.3V < V<sub>CC</sub> ≤ 2.7V unless otherwise specified)

Symbol	Parameter	Test Conditions		Value		Unit
		V <sub>CC</sub> (V)		-40 to 85 °C		
				Min.	Max.	
V <sub>IH</sub>	High Level Input Voltage	2.3 to 2.7		1.6		V
V <sub>IL</sub>	Low Level Input Voltage					0.7
V <sub>OH</sub>	High Level Output Voltage (A Outputs)	2.3 to 2.7	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = -100 μA	V <sub>CC</sub> - 0.2	V
		2.3		I <sub>O</sub> = -4 mA	2.0	
		2.3		I <sub>O</sub> = -6 mA	1.8	
		2.3		I <sub>O</sub> = -8 mA	1.7	
V <sub>OH</sub>	High Level Output Voltage (B Outputs)	2.3 to 2.7	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = -100 μA	V <sub>CC</sub> - 0.2	V
		2.3		I <sub>O</sub> = -6 mA	2.0	
		2.3		I <sub>O</sub> = -12 mA	1.8	
		2.3		I <sub>O</sub> = -18 mA	1.7	
V <sub>OL</sub>	Low Level Output Voltage (A Outputs)	2.3 to 2.7	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = 100 μA		V
		2.3		I <sub>O</sub> = 6 mA	0.4	
		2.3		I <sub>O</sub> = 8 mA	0.6	
V <sub>OL</sub>	Low Level Output Voltage (B Outputs)	2.3 to 2.7	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = 100 μA		V
		2.3		I <sub>O</sub> = 12 mA	0.4	
		2.3		I <sub>O</sub> = 18 mA	0.6	
I <sub>I</sub>	Input Leakage Current	2.3 to 2.7	V <sub>I</sub> = 0 to 3.6 V		±5	μA
I <sub>OZ</sub>	3 State Output Leakage Current	2.3 to 2.7	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>O</sub> = 0 to 3.6V		±10	μA
I <sub>off</sub>	Power Off Leakage Current	0	V <sub>I</sub> or V <sub>O</sub> = 0 to 3.6V		10	μA
I <sub>CC</sub>	Quiescent Supply Current	2.3 to 2.7	V <sub>I</sub> = V <sub>CC</sub> or GND		20	μA
			V <sub>I</sub> or V <sub>O</sub> = V <sub>CC</sub> to 3.6 V		±20	

**DC SPECIFICATIONS** ( $1.8V \leq V_{CC} \leq 2.3V$  unless otherwise specified)

Symbol	Parameter	Test Conditions		Value		Unit
		V <sub>CC</sub> (V)		-40 to 85 °C		
				Min.	Max.	
V <sub>IH</sub>	High Level Input Voltage	1.8 to 2.3		0.7V <sub>CC</sub>		V
V <sub>IL</sub>	Low Level Input Voltage				0.2V <sub>CC</sub>	V
V <sub>OH</sub>	High Level Output Voltage (A Outputs)	1.8	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = -100 μA	V <sub>CC</sub> - 0.2	V
		1.8		I <sub>O</sub> = -4 mA	1.4	
V <sub>OH</sub>	High Level Output Voltage (B Outputs)	1.8	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = -100 μA	V <sub>CC</sub> - 0.2	V
		1.8		I <sub>O</sub> = -6 mA	1.4	
V <sub>OL</sub>	Low Level Output Voltage (A Outputs)	1.8	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = 100 μA		V
		1.8		I <sub>O</sub> = 4 mA	0.2	
V <sub>OL</sub>	Low Level Output Voltage (B Outputs)	1.8	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = 100 μA		V
		1.8		I <sub>O</sub> = 6 mA	0.2	
I <sub>I</sub>	Input Leakage Current	1.8	V <sub>I</sub> = 0 to 3.6 V		±5	μA
I <sub>OZ</sub>	3 State Output Leakage Current	1.8	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>O</sub> = 0 to 3.6V		±10	μA
I <sub>off</sub>	Power Off Leakage Current	0	V <sub>I</sub> or V <sub>O</sub> = 0 to 3.6V		10	μA
I <sub>CC</sub>	Quiescent Supply Current	1.8	V <sub>I</sub> = V <sub>CC</sub> or GND		20	μA
			V <sub>I</sub> or V <sub>O</sub> = V <sub>CC</sub> to 3.6 V		±20	

**DYNAMIC SWITCHING CHARACTERISTICS** (T<sub>a</sub> = 25°C, Input t<sub>r</sub> = t<sub>f</sub> = 2.0ns, C<sub>L</sub> = 30pF)

Symbol	Parameter	Test Conditions		Value			Unit
		V <sub>CC</sub> (V)		T <sub>A</sub> = 25 °C			
				Min.	Typ.	Max.	
V <sub>OLP</sub>	Dynamic Peak Low Voltage Quiet Output (note 1, 3), A to B	1.8	V <sub>IL</sub> = 0 V V <sub>IH</sub> = V <sub>CC</sub>		0.25		V
		2.5			0.6		
		3.3			0.8		
V <sub>OLP</sub>	Dynamic Peak Low Voltage Quiet Output (note 1, 3) B to A	1.8	V <sub>IL</sub> = 0 V V <sub>IH</sub> = V <sub>CC</sub>		0.15		V
		2.5			0.25		
		3.3			0.35		
V <sub>OLV</sub>	Dynamic Valley Low Voltage Quiet Output (note 1, 3) A to B	1.8	V <sub>IL</sub> = 0 V V <sub>IH</sub> = V <sub>CC</sub>		-0.25		V
		2.5			-0.6		
		3.3			-0.8		
V <sub>OLV</sub>	Dynamic Valley Low Voltage Quiet Output (note 1, 3) B to A	1.8	V <sub>IL</sub> = 0 V V <sub>IH</sub> = V <sub>CC</sub>		-0.15		V
		2.5			-0.25		
		3.3			-0.35		
V <sub>OHV</sub>	Dynamic Valley High Voltage Quiet Output (note 2, 3) A to B	1.8	V <sub>IL</sub> = 0 V V <sub>IH</sub> = V <sub>CC</sub>		1.5		V
		2.5			1.9		
		3.3			2.2		
V <sub>OHV</sub>	Dynamic Valley High Voltage Quiet Output (note 2, 3) B to A	1.8	V <sub>IL</sub> = 0 V V <sub>IH</sub> = V <sub>CC</sub>		1.55		V
		2.5			2.05		
		3.3			2.65		

1) Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH to LOW or LOW to HIGH. The remaining output is measured in the LOW state.  
 2) Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH to LOW or LOW to HIGH. The remaining output is measured in the HIGH state.  
 3) Parameters guaranteed by design.



**AC ELECTRICAL CHARACTERISTICS** ( $C_L = 30$  pF,  $R_L = 500$   $\Omega$ , Input  $t_r = t_f = 2.0$  ns)

Symbol	Parameter	Test Condition		Value		Unit
		V <sub>CC</sub> (V)	Waveform	-40 to 85 °C		
				Min.	Max.	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time A to B	1.8	1	1.5	5.0	ns
		2.3 to 2.7		1.0	3.0	
		3.0 to 3.6		0.8	2.5	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time B to A	1.8	1	1.5	5.7	ns
		2.3 to 2.7		1.0	4.3	
		3.0 to 3.6		0.8	3.4	
t <sub>PZL</sub> t <sub>PZH</sub>	Output Enable Time A to B	1.8	2	1.5	7.5	ns
		2.3 to 2.7		1.0	4.9	
		3.0 to 3.6		0.8	3.8	
t <sub>PZL</sub> t <sub>PZH</sub>	Output Enable Time B to A	1.8	2	1.5	7.6	ns
		2.3 to 2.7		1.0	5.7	
		3.0 to 3.6		0.8	4.2	
t <sub>PLZ</sub> t <sub>PHZ</sub>	Output Disable Time A to B	1.8	2	1.5	5.5	ns
		2.3 to 2.7		1.0	4.2	
		3.0 to 3.6		0.8	3.7	
t <sub>PLZ</sub> t <sub>PHZ</sub>	Output Disable Time B to A	1.8	2	1.5	5.7	ns
		2.3 to 2.7		1.0	4.8	
		3.0 to 3.6		0.8	4.1	
t <sub>OSLH</sub> t <sub>OSSL</sub>	Output to Output Skew Time (note 1, 2)	1.8			0.5	ns
		2.3 to 2.7			0.5	
		3.0 to 3.6			0.5	

1) Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW ( $t_{OSLH} = |t_{PLHn} - t_{PLHn}|$ ,  $t_{OSSL} = |t_{PHLn} - t_{PHLn}|$ )

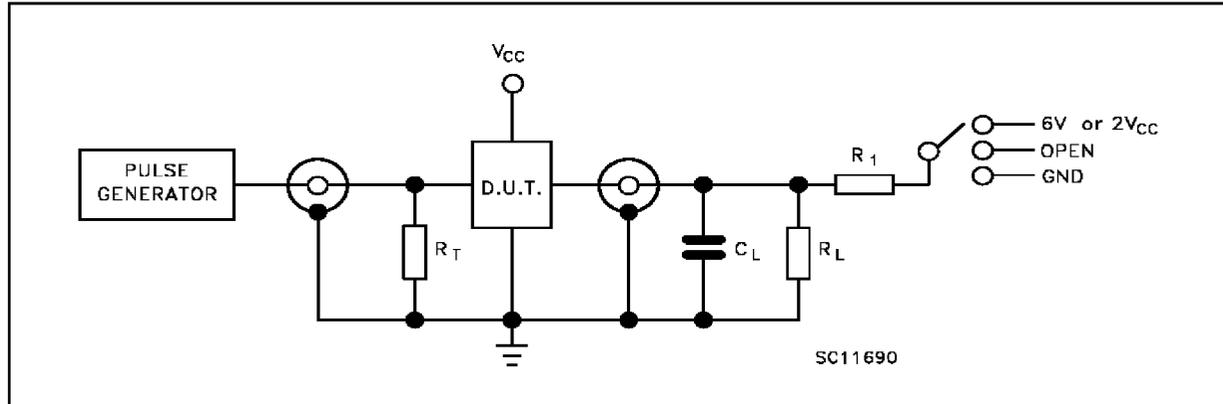
2) Parameter guaranteed by design

**CAPACITIVE CHARACTERISTICS**

Symbol	Parameter	Test Conditions		Value			Unit
		V <sub>CC</sub> (V)		T <sub>A</sub> = 25 °C			
				Min.	Typ.	Max.	
C <sub>IN</sub>	Input Capacitance	1.8, 2.5 or 3.3	V <sub>IN</sub> = 0V or V <sub>CC</sub>		4		pF
C <sub>OUT</sub>	Output Capacitance	1.8, 2.5 or 3.3	V <sub>IN</sub> = 0V or V <sub>CC</sub>		8		pF
C <sub>PD</sub>	Power Dissipation Capacitance (note 1)	1.8, 2.5 or 3.3	f <sub>IN</sub> = 10MHz V <sub>IN</sub> = 0V or V <sub>CC</sub>		28		pF

1) C<sub>PD</sub> is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the following equation.  $I_{CC(oper)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16$  (per circuit)

TEST CIRCUIT



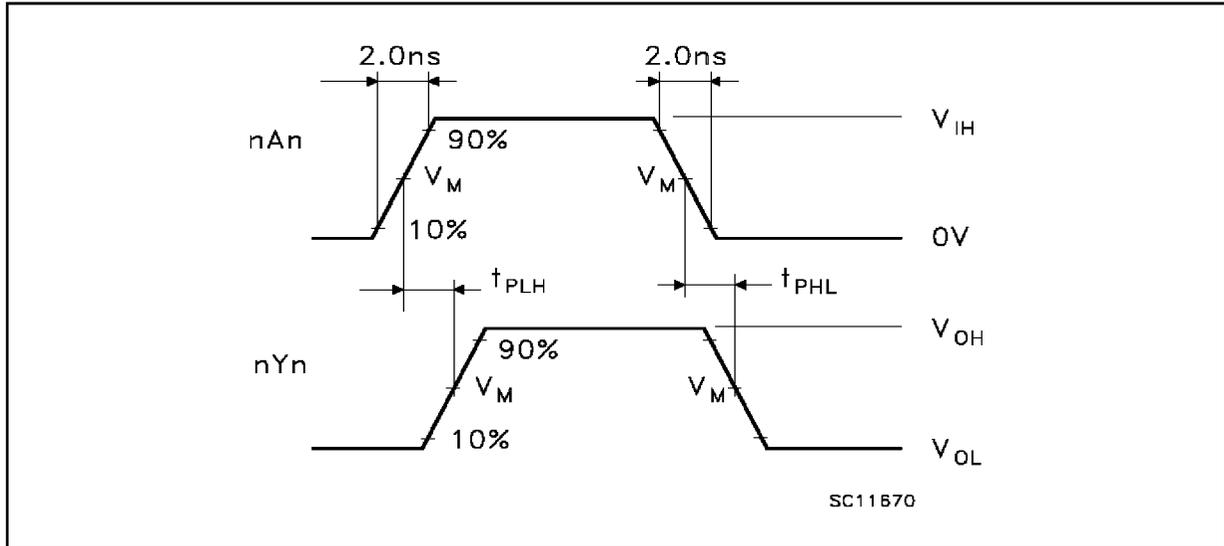
TEST	SWITCH
$t_{PLH}$ , $t_{PHL}$	Open
$t_{PZL}$ , $t_{PLZ}$ ( $V_{CC} = 3.0$ to $3.6V$ )	6V
$t_{PZL}$ , $t_{PLZ}$ ( $V_{CC} = 2.3$ to $2.7V$ or $1.8V$ )	$2V_{CC}$
$t_{PZH}$ , $t_{PHZ}$	GND

$C_L = 30$  pF or equivalent (includes jig and probe capacitance)  
 $R_L = R_1 = 500\Omega$  or equivalent  
 $R_T = Z_{OUT}$  of pulse generator (typically  $50\Omega$ )

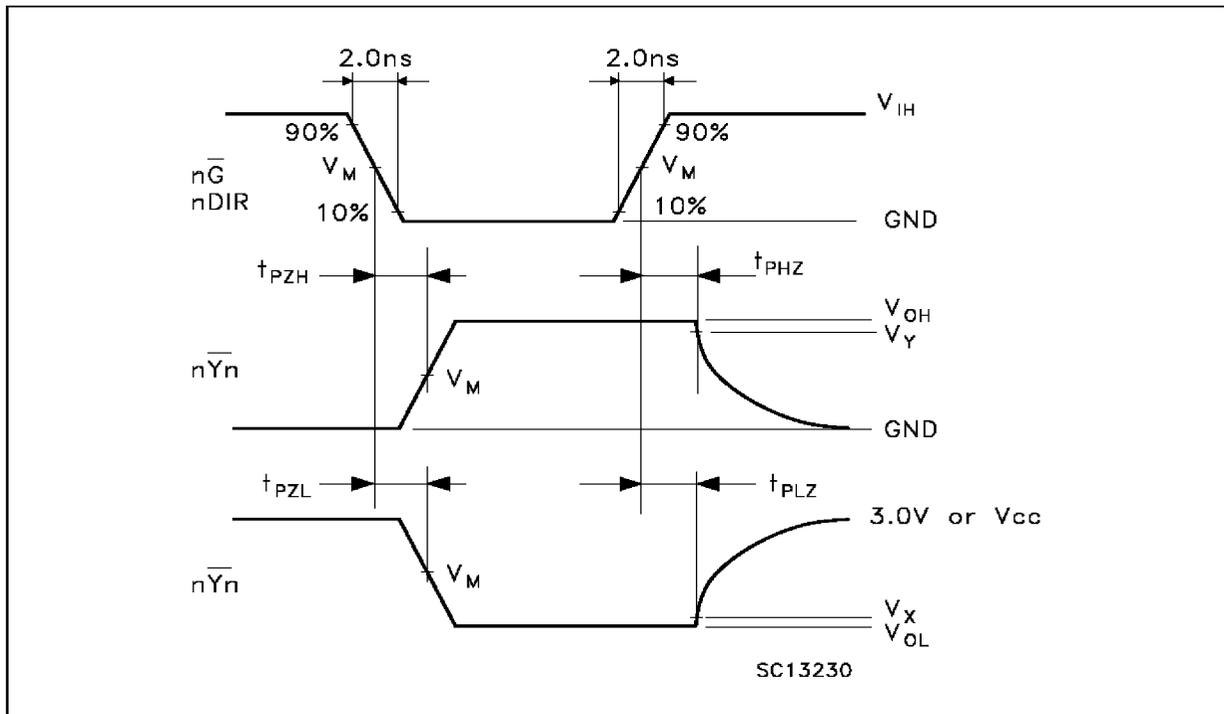
WAVEFORM SYMBOL VALUES

Symbol	$V_{CC}$		
	3.0 to 3.6V	2.3 to 2.7V	1.8V
$V_{IH}$	2.7V	$V_{CC}$	$V_{CC}$
$V_M$	1.5V	$V_{CC}/2$	$V_{CC}/2$
$V_X$	$V_{OL} + 0.3V$	$V_{OL} + 0.15V$	$V_{OL} + 0.15V$
$V_Y$	$V_{OH} - 0.3V$	$V_{OH} - 0.15V$	$V_{OH} - 0.15V$

**WAVEFORM 1: PROPAGATION DELAYS** (f=1MHz; 50% duty cycle)

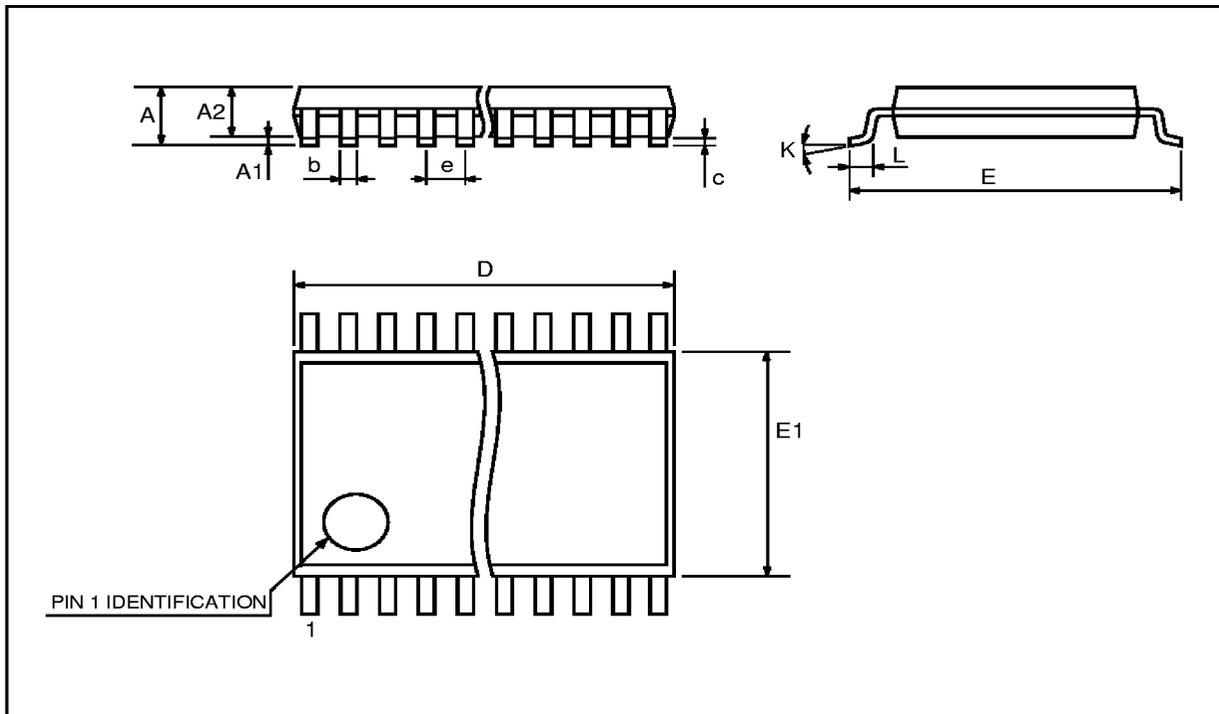


**WAVEFORM 2: OUTPUT ENABLE AND DISABLE TIME** (f=1MHz; 50% duty cycle)



**TSSOP48 MECHANICAL DATA**

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.1			0.433
A1	0.05	0.10	0.15	0.002	0.004	0.006
A2	0.85	0.9	0.95	0.335	0.354	0.374
b	0.17		0.27	0.0067		0.011
c	0.09		0.20	0.0035		0.0079
D	12.4	12.5	12.6	0.408	0.492	0.496
E	7.95	8.1	8.25	0.313	0.319	0.325
E1	6.0	6.1	6.2	0.236	0.240	0.244
e		0.5 BSC			0.0197 BSC	
K	0°	4°	8°	0°	4°	8°
L	0.50	0.60	0.70	0.020	0.024	0.028



Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specification mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a trademark of STMicroelectronics

© 1999 STMicroelectronics – Printed in Italy – All Rights Reserved  
STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - Canada - China - France - Germany - Italy - Japan - Korea - Malaysia - Malta - Mexico - Morocco - The Netherlands -  
Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A.  
<http://www.st.com>

